This user's guide describes the TPS62737 evaluation module (EVM). The TPS62737 device is a high-frequency synchronous stepdown dc-dc converter optimized for ultralow-power energy harvesting applications. The converter can provide up to 2900 mA of continuous current to a 1.3- to 5.3-V output from input voltages up to 5.5 V.

Contents

1 Introduction ........................................................................................................................................... 2
  1.1 TPS62737 IC Features ................................................................................................................... 2
  1.2 TPS62737EVM Features ............................................................................................................. 2
  1.3 TPS62737EVM Schematic ........................................................................................................... 3
2 Performance Specification Summary ...................................................................................................... 4
3 Test Summary ........................................................................................................................................ 4
  3.1 Recommended Equipment ........................................................................................................... 4
  3.2 Equipment and EVM Setup .......................................................................................................... 4
  3.3 Tips when Measuring Efficiency ................................................................................................. 5
  3.4 Tips for Taking Scope Plots ......................................................................................................... 5
  3.5 Test Results .................................................................................................................................. 6
4 PWR560 PCB Layout and Bill of Materials ......................................................................................... 8
  4.1 REV A PCB Layout ..................................................................................................................... 8
  4.2 Bill of Materials .......................................................................................................................... 9

List of Figures

1 TPS62737 EVM Board Schematic ...................................................................................................... 3
2 EVM Test Setup for Measuring Efficiency ......................................................................................... 5
3 Ship-Mode Startup Behavior, \( V_{\text{IN}} = 3.6 \text{V}, V_{\text{OUT}} = 1.8 \text{V} \) ........................................... 6
4 Standby Mode Startup Behavior, \( V_{\text{IN}} = 3.6 \text{V}, V_{\text{OUT}} = 1.8 \text{V} \) ........................................... 6
5 Load Transient Response, \( V_{\text{IN}} = 3.6 \text{V}, V_{\text{OUT}}=1.8\text{V} \) ...................................................... 7
6 Steady State Operation, \( V_{\text{IN}} = 3.6 \text{V}, V_{\text{OUT}} = 1.8 \text{V}, R_{\text{OUT}}=9 \Omega \) .......................... 7
7 Top Layer ........................................................................................................................................... 8
8 Bottom Layer ..................................................................................................................................... 8
1 Introduction

1.1 TPS62737 IC Features

The TPS62737 is a highly integrated ultra low power buck converter solution that is well suited for meeting the special needs of ultra low power applications such as energy harvesting. The TPS62737 provides the system with an externally programmable regulated supply in order to preserve the overall efficiency of the power management stage versus a linear step down converter. Although intended to have input power from an energy storage element such as a Li-ion battery or super cap, the TPS62737 can accept any input voltage up to 5.5 V, while supplying the rail to low voltage electronics.

The TPS62737 integrates an optimized hysteretic controller for low power applications. The internal circuitry utilizes a time based sampling system in order to reduce the average quiescent current. This allows for the quiescent current consumption to scale with output load levels. The regulated output has been optimized to provide high efficiency across low output currents (< 10 µA) to high currents (200 mA).

To further assist users in the strict management of their energy budgets, the TPS62737 toggles the input good (VIN_OK) flag to signal an attached microprocessor when the voltage on the input supply has dropped below a pre-set critical level. The intent of VIN_OK is to trigger the reduction of load currents to prevent the system from entering an undervoltage condition. Two separate enable signals allow the user to enable/disable the regulated output or place IC into an ultra-low quiescent sleep state. Two separate enable signals allow the enabling or disabling of the regulated output or allow putting the IC into an ultra-low quiescent sleep state.

The output voltage regulation point and input good threshold are set by external resistors. In order to maximize efficiency at light load, the use of voltage level setting resistors > 1 MΩ is recommended. However, during board assembly or modification, contaminants such as solder flux and even some board cleaning agents can leave residue that may form parasitic resistors across the physical resistors and/or from one end of a resistor to ground, especially in humid, fast airflow environments. This can result in the voltage regulation and threshold levels changing significantly from those expected per the installed resistor values. Therefore, the boards must be carefully cleaned then rinsed with de-ionized water until the ionic contamination of that water. If this is not feasible, then it is recommended that the sum of the voltage setting resistors be reduced.

1.2 TPS62737EVM Features

1. Input voltage range from 2.0 V to 5.5 V
2. Output voltage set to 1.8 V but adjustable from 1.3 V to 5.3 V with external resistors
3. VIN_OK threshold of 2.9 V but adjustable from VOUT to 5.3 V with external resistors
4. Easily accessible headers for IN, IN-SENSE, OUT, OUT-SENSE, GND, VIN_OK
5. Jumpers for EN1 and EN2
1.3 TPS62737EVM Schematic

Figure 1. TPS62737 EVM Board Schematic
2 Performance Specification Summary

<table>
<thead>
<tr>
<th>Specification</th>
<th>Conditions</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input dc voltage, IN</td>
<td></td>
<td>2.0</td>
<td>5.5</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Output dc voltage, OUT</td>
<td>Adjustable by changing external resistors from 1.3 V to 5.3 V</td>
<td>1.8</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>VBAT_OK threshold</td>
<td>Adjustable by changing external resistors from OUT to 5.3 V</td>
<td>2.9</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Output current</td>
<td></td>
<td>0</td>
<td>200</td>
<td></td>
<td>mA</td>
</tr>
</tbody>
</table>

3 Test Summary

3.1 Recommended Equipment

- Adjustable dc power supply between 2.0 V and 5.5 V with the adjustable current limit set to approximately 400 mA
- Load: system load or resistive load \( \geq 9 \Omega \)
- Two digital multimeters configured to measure voltage (equivalent or better)
- Two digital multimeters configured to measure current (equivalent or better). **NOTE:** Due to the input current pulses inherent to a hysteretically-controlled converter, the input current meter must be capable of filtering and/or averaging in order to measure the correct value. Adding a large (> 100 \( \mu \)F) capacitor between IN and GND may be used to assist with filtering; however, such capacitors tend to have high leakage currents that may artificially increase quiescent current measurements at no load. Use of a sourcemeter, configured to regulate voltage and measure current, or power, or both current and power is also recommended when taking efficiency measurements.
- Oscilloscope with up to four voltage probes

3.2 Equipment and EVM Setup

**Table 1. Setup I/O Connections and Configuration for Measuring Efficiency of TPS62737 EVM**

<table>
<thead>
<tr>
<th>Jack and Component (Silk Screen)</th>
<th>Description</th>
<th>Connect or Adjustment To:</th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>J1 (IN)</td>
<td>Negative lead of current meter (CM#1)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>J2-1 (+ IN SNS)</td>
<td>Kelvin connection to capacitance</td>
<td>Positive lead of voltmeter (VM#1)</td>
<td></td>
</tr>
<tr>
<td>J2-2 (- GND SNS)</td>
<td>Kelvin connection to capacitance</td>
<td>Negative lead of voltmeter (VM#1)</td>
<td></td>
</tr>
<tr>
<td>J3 (GND)</td>
<td>Power supply negative lead</td>
<td></td>
<td></td>
</tr>
<tr>
<td>J4 (OUT)</td>
<td>Positive lead of current meter (CM#2)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>J5-1 (+ OUT SNS)</td>
<td>Kelvin connection to capacitance</td>
<td>Positive lead of voltmeter (VM#2)</td>
<td></td>
</tr>
<tr>
<td>J5-2 (- GND SNS)</td>
<td>Kelvin connection to capacitance</td>
<td>Negative lead of voltmeter (VM#2)</td>
<td></td>
</tr>
<tr>
<td>J6 (GND)</td>
<td>Negative lead to load resistance</td>
<td></td>
<td></td>
</tr>
<tr>
<td>J7-1 (VIN_OK)</td>
<td>Push-pull output of comparator that indicates the status of the input voltage</td>
<td>n/a</td>
<td></td>
</tr>
<tr>
<td>J7-2 (GND)</td>
<td></td>
<td>n/a</td>
<td></td>
</tr>
<tr>
<td>JP1 (EN1)</td>
<td>EN1 = HI and EN2 = x implements full standby mode. Switching converter and VIN_OK indication is off (ship mode).</td>
<td>EN1 = LO</td>
<td></td>
</tr>
<tr>
<td>JP2 (EN2)</td>
<td>EN1 = LO and EN2 = HI implements full buck converter mode. EN1 = LO and EN2 = LO implements partial standby mode. Switching converter is off, but VIN_OK indication is on.</td>
<td>EN2 = HI</td>
<td></td>
</tr>
</tbody>
</table>
Table 1 and Figure 2 show the test setup for measuring efficiency.

3.3 Tips when Measuring Efficiency

1. Ensure that the EVM setup is according to Table 1 and Figure 2, and preset the power supply to a voltage less than 5.5 V at a current limit of approximately 400 mA.
2. Slowly increase the system load current until 200 mA is reached.
3. The TPS62737 datasheet has efficiency plots at various input voltages, output voltages and load currents.

3.4 Tips for Taking Scope Plots

1. A current loop was inserted in series with the inductor for taking the inductor current measurements.
2. If measuring DC waveforms, set the timebase as shown in the plot and connect the probes to the applicable headers (IN, OUT, VBAT_OK) or SW pin and the closest GND header.
3. If measuring AC waveforms such as output voltage ripple, set the timebase as shown in the plot, remove the voltage probe hat, connect the probe tip to the top of capacitor C3 and a short ground lead to capacitor C3's ground.
4. Please note that when measuring switching waveforms, the timebase may need to be adjusted as the output load current adjusts due to the hysteretic control methodology.
3.5 Test Results

Figure 3 through Figure 6 detail various test results for the EVM.

Figure 3. Ship-Mode Startup Behavior, $V_{IN} = 3.6V$, $V_{OUT} = 1.8V$

Figure 4. Standby Mode Startup Behavior, $V_{IN} = 3.6V$, $V_{OUT} = 1.8V$
Figure 5. Load Transient Response, $V_{IN} = 3.6\,\text{V}$, $V_{OUT} = 1.8\,\text{V}$

Figure 6. Steady State Operation, $V_{IN} = 3.6\,\text{V}$, $V_{OUT} = 1.8\,\text{V}$, $R_{OUT} = 9\,\Omega$
4.1 REV A PCB Layout

Figure 7. Top Layer

Figure 8. Bottom Layer
4.2 Bill of Materials

Table 2 lists the BOM for this EVM.

Table 2. PWR560 Bill of Materials

<table>
<thead>
<tr>
<th>Designator</th>
<th>Qty</th>
<th>Value</th>
<th>Description</th>
<th>Package Reference</th>
<th>Part Number</th>
<th>Manufacturer</th>
</tr>
</thead>
<tbody>
<tr>
<td>PCB</td>
<td>1</td>
<td></td>
<td>Printed Circuit Board</td>
<td></td>
<td>PWR560</td>
<td>Any</td>
</tr>
<tr>
<td>C1</td>
<td>1</td>
<td>0.1uF</td>
<td>Capacitor, Ceramic Chip, 10 V, X7R, ±10%</td>
<td>603</td>
<td>C0603C104KRACTU</td>
<td>Kemet</td>
</tr>
<tr>
<td>C2</td>
<td>1</td>
<td>22 uF</td>
<td>Capacitor, Ceramic Chip, 10 V, X5R, ±10%</td>
<td>603</td>
<td>C1608X5R1A226M080AC</td>
<td>TDK</td>
</tr>
<tr>
<td>C3</td>
<td>1</td>
<td>22uF</td>
<td>Capacitor, Ceramic Chip, 10 V, X5R, ±10%</td>
<td>603</td>
<td>C1608X5R1A226M080AC</td>
<td>TDK</td>
</tr>
<tr>
<td>C4</td>
<td>0</td>
<td>Open</td>
<td>Capacitor, Ceramic Chip, xxV, ±10%</td>
<td>1210</td>
<td>Std</td>
<td>STD</td>
</tr>
<tr>
<td>J1, J2, J3, J4, J5, J6, J7</td>
<td>7</td>
<td></td>
<td>Header, Male 2-pin, 100mil spacing.</td>
<td>0.100 inch x 2</td>
<td>PEC02SAAN</td>
<td>Sullins</td>
</tr>
<tr>
<td>JP1, JP2</td>
<td>2</td>
<td>PEC03SAAN</td>
<td>Header, Male 3-pin, 100mil spacing,</td>
<td>0.100 inch x 3</td>
<td>PEC02SAAN</td>
<td>Sullins</td>
</tr>
<tr>
<td>L1</td>
<td>1</td>
<td>10 uH</td>
<td>Inductor, SMT, 1.4A, 216mΩ</td>
<td>2.5mm x 2.0mm x 1.20mm</td>
<td>DFE25021C-1239AS-H-100M</td>
<td>Wurth Elektronik</td>
</tr>
<tr>
<td>R1</td>
<td>1</td>
<td>5.49M</td>
<td>Resistor, Chip, 1/16W, 1%</td>
<td>603</td>
<td>CRCW0603M40FKEA</td>
<td>Vishay</td>
</tr>
<tr>
<td>R2</td>
<td>1</td>
<td>3.4M</td>
<td>Resistor, Chip, 1/16W, 1%</td>
<td>603</td>
<td>CRCW0603M40FKEA</td>
<td>Vishay</td>
</tr>
<tr>
<td>R3</td>
<td>1</td>
<td>4.32M</td>
<td>Resistor, Chip, 1/16W, 1%</td>
<td>603</td>
<td>CRCW0603M40FKEA</td>
<td>Vishay</td>
</tr>
<tr>
<td>U1</td>
<td>1</td>
<td></td>
<td>Programmable Output Voltage Ultra-Low Power Buck Converter with up to 50mA / 200 mA Output Current, RGY0014A</td>
<td>RGY0014A</td>
<td>TPS62737RGY</td>
<td>Texas Instruments</td>
</tr>
</tbody>
</table>

Revision History

Changes from Original (July 2013) to A Revision

• Changed bill of materials. ................................................................. 9

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.
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Safety-Critical or Life-Critical Applications. If user intends to use EVMs in evaluations of safety critical applications (such as life support), and a failure of a TI product considered for purchase by user for use in user's product would reasonably be expected to cause severe personal injury or death such as devices which are classified as FDA Class III or similar classification, then user must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.
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General Statement for EVMs including a radio

User Power/Frequency Use Obligations: For EVMs including a radio, the radio included in such EVMs is intended for development and/or professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability in such EVMs and their development application(s) must comply with local laws governing radio spectrum allocation and power limits for such EVMs. It is the user’s sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by TI unless user has obtained appropriate experimental and/or development licenses from local regulatory authorities, which is the sole responsibility of the user, including its acceptable authorization.

U.S. Federal Communications Commission Compliance

For EVMs Annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation. Changes or modifications could void the user’s authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at its own expense.

FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

• Reorient or relocate the receiving antenna.
• Increase the separation between the equipment and receiver.
• Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
• Consult the dealer or an experienced radio/TV technician for help.

Industry Canada Compliance (English)

For EVMs Annotated as IC – INDUSTRY CANADA Compliant:

This Class A or B digital apparatus complies with Canadian ICES-003. Changes or modifications not expressly approved by the party responsible for compliance could void the user’s authority to operate the equipment.

Concerning EVMs Including Radio Transmitters

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concerning EVMs Including Detachable Antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.
Canada Industry Canada Compliance (French)

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l’autorité de l'utilisateur pour actionner l’équipement.

Concernant les EVMs avec appareils radio

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concernant les EVMs avec antennes déetchables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

Important Notice for Users of EVMs Considered “Radio Frequency Products” in Japan

EVMs entering Japan are NOT certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If user uses EVMs in Japan, user is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry’s Rule for Enforcement of Radio Law of Japan.
2. Use EVMs only after user obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after user obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless user gives the same notice above to the transferee. Please note that if user does not follow the instructions above, user will be subject to penalties of Radio Law of Japan.

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